

Bill of Materials

TDA-00782_ DLP4501 Board

Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer Part Number	Alternate Part	PCB Footprint	Note
1	5	C1 C2 C3 C4 C6	0.1 uF	CAP CER 0.1UF 10V 10% X7R 0402	Kemet	C0402C104K8RACTU		0402	
2	1	CS	0.1 uF	CAP CER 0.1UF 25V 10% X7R 0603	Panasonic	ECJ-1VB1E104K	0603		
3	1	J1	AXT580124	CONN SOCKET FPC .4MM 80POS SMD	Panasonic	AXT580124			
4	1	J2	50039-06001-001	CONN-PLUG-60Pin-0.5MM	Aces	50039-06001-001			Made in Taiwan - Layout has to be modified when choicing a different connector

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